BF908; BF908R

Dual-gate MOS-FETs

Rev. 03 — 14 November 2007

Product data sheet

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NXP Semiconductors



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BF908; BF908R

FEATURES

- · High forward transfer admittance
- Short channel transistor with high forward transfer admittance to input capacitance ratio
- Low noise gain controlled amplifier up to 1 GHz.

APPLICATIONS

 VHF and UHF applications with 12 V supply voltage, such as television tuners and professional communications equipment.

DESCRIPTION

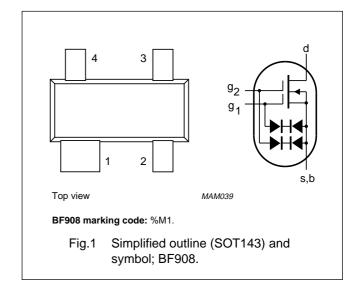
Depletion type field-effect transistor in a plastic microminiature SOT143 or SOT143R package. The transistors are protected against excessive input voltage surges by integrated back-to-back diodes between gates and source.

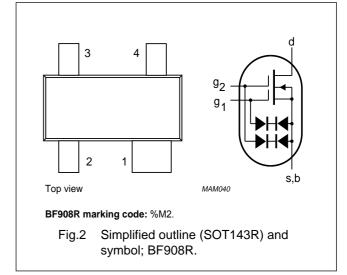
CAUTION

The device is supplied in an antistatic package. The gate-source input must be protected against static discharge during transport or handling.

PINNING

PIN	SYMBOL	DESCRIPTION
1	s, b	source
2	d	drain
3	g ₂	gate 2
4	91	gate 1





QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{DS}	drain-source voltage		_	_	12	V
I _D	drain current		_	_	40	mA
P _{tot}	total power dissipation		_	_	200	mW
Tj	operating junction temperature		_	_	150	°C
y _{fs}	forward transfer admittance		36	43	50	mS
C _{ig1-s}	input capacitance at gate 1		2.4	3.1	4	pF
C _{rs}	reverse transfer capacitance	f = 1 MHz	20	30	45	pF
F	noise figure	f = 800 MHz	_	1.5	2.5	dB

Dual-gate MOS-FETs

BF908; BF908R

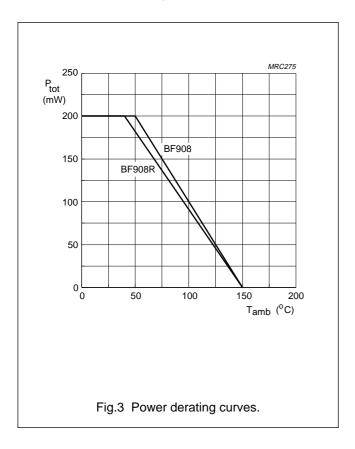
LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{DS}	drain-source voltage		_	12	V
I _D	drain current		_	40	mA
±I _{G1}	gate 1 current		_	10	mA
±I _{G2}	gate 2 current		_	10	mA
P _{tot}	total power dissipation	see Fig.3; note 1			
	BF908	up to T _{amb} = 50 °C	_	200	mW
	BF908R	up to T _{amb} = 40 °C	_	200	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	operating junction temperature		_	150	°C

Note

1. Device mounted on a printed-circuit board.



Dual-gate MOS-FETs

BF908; BF908R

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	note 1		
	BF908		500	K/W
	BF908R		550	K/W

Note

1. Device mounted on a printed-circuit board.

STATIC CHARACTERISTICS

 $T_i = 25$ °C; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
±V _{(BR)G1-SS}	gate 1-source breakdown voltage	$V_{G2-S} = V_{DS} = 0$; $I_{G1-S} = 10 \text{ mA}$	8	_	20	V
±V _{(BR)G2-SS}	gate 2-source breakdown voltage	$V_{G1-S} = V_{DS} = 0$; $I_{G2-S} = 10 \text{ mA}$	8	_	20	V
-V _{(P)G1-S}	gate 1-source cut-off voltage	$V_{G2-S} = 4 \text{ V}; V_{DS} = 8 \text{ V}; I_D = 20 \mu A$	_	_	2	V
-V _{(P)G2-S}	gate 2-source cut-off voltage	$V_{G1-S} = 4 \text{ V}; V_{DS} = 8 \text{ V}; I_D = 20 \mu A$	_	_	1.5	V
I _{DSS}	drain-source current	$V_{G2-S} = 4 \text{ V}; V_{DS} = 8 \text{ V}; V_{G1-S} = 0$	3	15	27	mA
±I _{G1-SS}	gate 1 cut-off current	$V_{G2-S} = V_{DS} = 0; V_{G1-S} = 5 V$	_	_	50	nA
±I _{G2-SS}	gate 2 cut-off current	$V_{G1-S} = V_{DS} = 0; V_{G2-S} = 5 \text{ V}$	_	_	50	nA

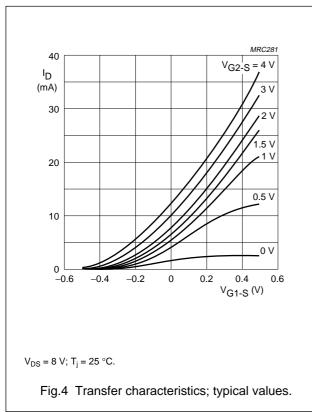
DYNAMIC CHARACTERISTICS

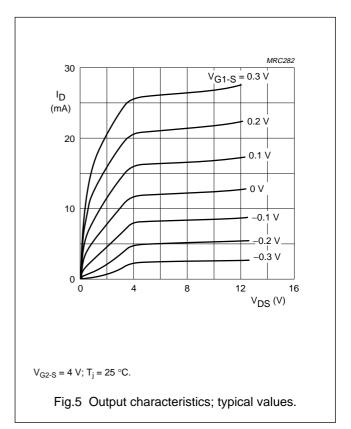
Common source; T_{amb} = 25 °C; V_{DS} = 8 V; V_{G2-S} = 4 V; I_D = 15 mA; unless otherwise specified.

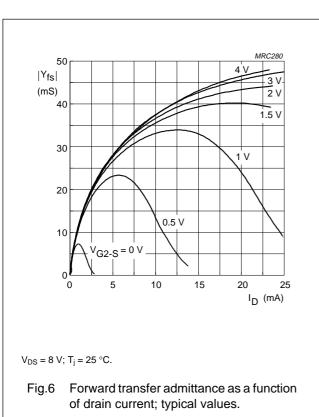
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
y _{fs}	forward transfer admittance	pulsed; T _j = 25 °C; f = 1 MHz	36	43	50	mS
C _{ig1-s}	input capacitance at gate 1	f = 1 MHz	2.4	3.1	4	pF
C _{ig2-s}	input capacitance at gate 2	f = 1 MHz	1.2	1.8	2.5	pF
Cos	output capacitance	f = 1 MHz	1.2	1.7	2.2	pF
C _{rs}	reverse transfer capacitance	f = 1 MHz	20	30	45	fF
F	noise figure	$f = 200 \text{ MHz}; G_S = 2 \text{ mS}; B_S = B_{Sopt}$	_	0.6	1.2	dB
		$f = 800 \text{ MHz}$; $G_S = G_{Sopt}$; $B_S = B_{Sopt}$	_	1.5	2.5	dB

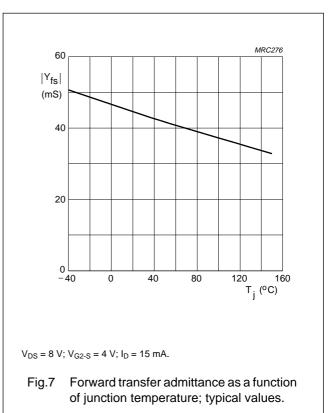
Dual-gate MOS-FETs

BF908; BF908R









Dual-gate MOS-FETs

BF908; BF908R

Table 1 Scattering parameters

	s ₁₁		S ₂₁		S ₁₂		S ₂₂	
f (MHz)	MAGNITUDE (ratio)	ANGLE (deg)	MAGNITUDE (ratio)	ANGLE (deg)	MAGNITUDE (ratio)	ANGLE (deg)	MAGNITUDE (ratio)	ANGLE (deg)
V _{DS} = 8	3 V; V _{G2-S} = 4 V; I	_D = 10 mA	; T _{amb} = 25 °C.					
50	0.998	-5.1	3.537	173.5	0.001	98.2	0.996	-2.4
100	0.994	-10.4	3.502	167.7	0.001	88.8	0.994	-4.9
200	0.979	-20.8	3.450	154.9	0.003	74.6	0.987	-9.5
300	0.962	-30.3	3.318	143.7	0.004	69.5	0.983	-13.9
400	0.939	-40.1	3.234	131.9	0.005	65.6	0.980	-18.5
500	0.914	-49.1	3.093	120.7	0.006	64.4	0.974	-22.8
600	0.892	-57.1	2.912	111.1	0.005	63.1	0.969	-27.0
700	0.865	-64.4	2.774	101.0	0.005	65.2	0.966	-31.2
800	0.837	-71.6	2.616	91.4	0.004	70.8	0.965	-35.4
900	0.811	-78.1	2.479	81.9	0.004	87.4	0.965	-39.4
1000	0.785	-84.5	3.329	72.5	0.003	108.0	0.966	-43.7
V _{DS} = 8	3 V; V _{G2-S} = 4 V; I	_D = 15 mA	$T_{amb} = 25 ^{\circ}C$.					
50	0.998	-5.3	3.983	173.4	0.001	95.5	0.994	-2.4
100	0.994	-10.9	3.943	167.5	0.001	93.6	0.991	-5.0
200	0.976	-21.6	3.878	154.7	0.003	74.3	0.984	-9.7
300	0.957	-31.7	3.722	143.3	0.004	70.0	0.979	-14.2
400	0.934	-41.7	3.614	131.6	0.005	63.5	0.975	-18.8
500	0.907	-51.1	3.446	120.4	0.006	62.2	0.969	-23.2
600	0.885	-59.1	3.240	110.9	0.005	59.6	0.964	-27.4
700	0.851	-66.8	3.072	100.9	0.005	64.8	0.961	-31.6
800	0.826	-73.9	2.891	91.3	0.004	67.8	0.959	-35.9
900	0.797	-80.7	2.733	81.9	0.004	85.0	0.958	-40.0
1000	0.773	-87.0	2.569	72.8	0.004	102.9	0.958	-44.2

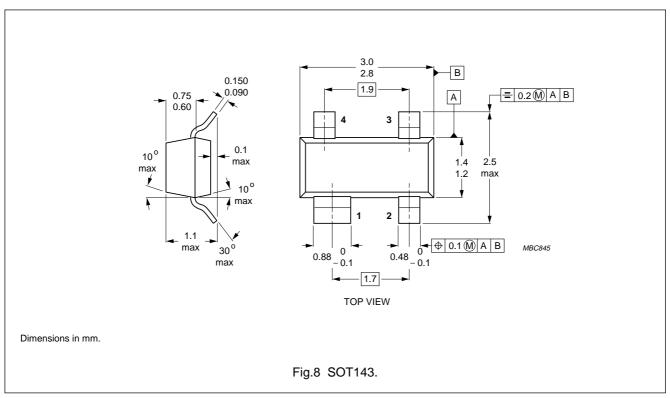
Table 2 Noise data

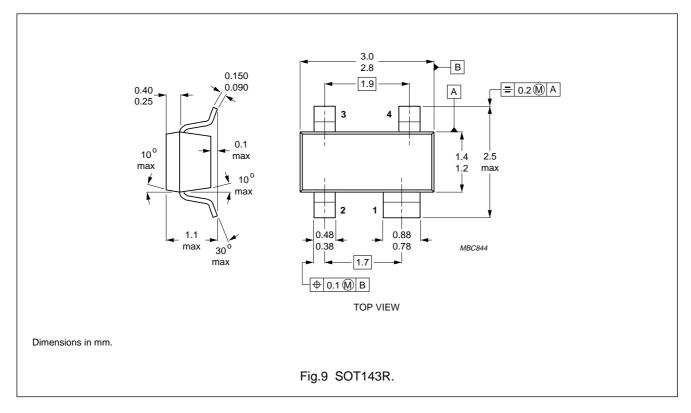
f	F _{min}	Γ	opt	_	
(MHz)	(dB)	(ratio)	(deg)	r _n	
V _{DS} = 8 V; V _{G2-S} = 4 V; I	$_{\rm D}$ = 10 mA; $\rm T_{amb}$ = 25 °C.				
800	1.50	0.720	56.7	0.580	
$V_{DS} = 8 \text{ V}; V_{G2-S} = 4 \text{ V}; I_D = 15 \text{ mA}; T_{amb} = 25 ^{\circ}\text{C}.$					
800	1.50	0.700	59.2	0.520	

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BF908; BF908R

PACKAGE OUTLINES





Dual-gate MOS-FETs

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Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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Revision history

Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BF908-R_N_3	20071114	Product data sheet	-	BF908-R_2
Modifications:	 Fig. 1 and 2 	2 on page 2; Figure note cha	nged	
BF908-R_2	19960730	Product specification	-	BF908R_1
BF908R_1	-	-	-	-

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